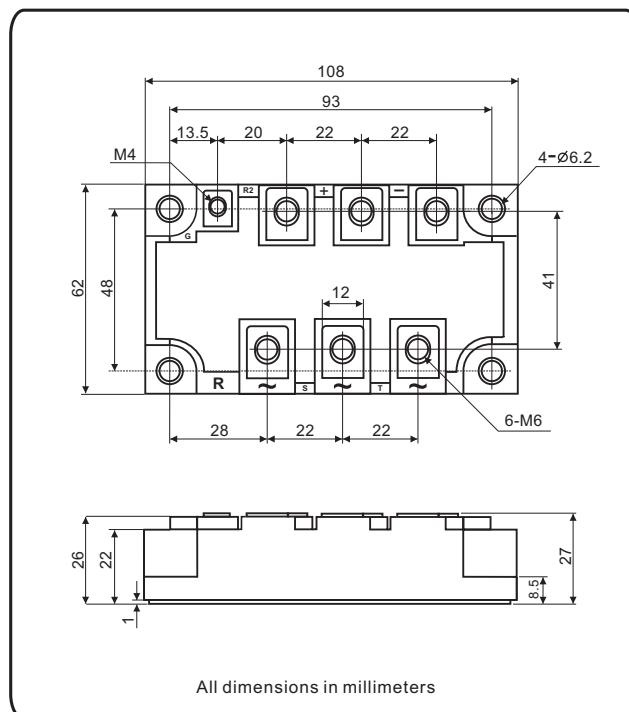


## Three-Phase Bridge + Thyristor, 200A

**MTPT20008 Thru MTPT20016**



### FEATURES

- UL recognition file number E320098
- Three-phase bridge and a thyristor
- High surge current capability
- Low thermal resistance
- Compliant to RoHS
- Isolation voltage up to 2500V

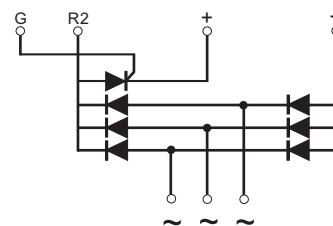


### Applications

- Inverter for AC or DC motor control
- Current stabilized power supply
- Switching power supply

### ADVANTAGE

- International standard package
- Epoxy meets UL 94 V-O flammability rating
- Small volume, light weight
- Small thermal resistance
- Weight: 470g (16.6 ozs)



### PRIMARY CHARACTERISTICS

$I_{F(AV)}$	200A
$V_{RRM}$	800V to 1600V
$I_{FSM}$	1900A
$I_R$	20 $\mu$ A
$V_{FM}/V_{TM}$	1.3V
$T_{J\max.}$	150°C

**◎ Maximum Ratings for Diodes**

MAJOR RATINGS AND CHARACTERISTICS ( $T_A = 25^\circ\text{C}$ unless otherwise noted)					
PARAMETER	SYMBOL	MTPT200			UNIT
		08	12	16	
Maximum repetitive peak reverse voltage	$V_{RRM}/V_{RRM}$	800	1200	1600	V
Peak reverse non-repetitive voltage	$V_{RSM}$	900	1300	1700	V
Output DC current three-phase full wave, $T_c = 100^\circ\text{C}$	$I_o$	200			A
Peak forward surge current single sine-wave superimposed on rated load	$I_{FSM}$	1900			A
Rating (non-repetitive, for $t$ greater than 1 ms and less than 8.3 ms) for fusing	$I^2t$	18050			$\text{A}^2\text{s}$
Operating junction temperature range	$T_J$	-40 to 150			$^\circ\text{C}$
Storage temperature range	$T_{STG}$	-40 to 125			$^\circ\text{C}$

ELECTRICAL CHARACTERISTICS ( $T_A = 25^\circ\text{C}$ unless otherwise noted)						
PARAMETER	TEST CONDITIONS	SYMBOL	MTPT200			UNIT
			08	12	16	
Maximum instantaneous forward drop per diode	$I_F = 200\text{A}$	$V_F$	1.3			V
Maximum reverse DC current at rated DC blocking voltage per diod	$T_A = 25^\circ\text{C}$	$I_R$	20			$\mu\text{A}$
	$T_A = 150^\circ\text{C}$		10			$\text{mA}$

**◎ Maximum Ratings fo Thyristor**

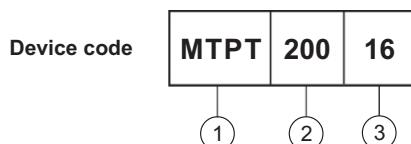
FORWARD CONDUCTION								
PARAMETER	SYMBOL	TEST CONDITIONS			VALUES	UNITS		
Maximum average on-state current at case temperature	$I_{T(AV)}$	180° conduction, half sine wave ,50Hz			200	A		
					85	$^\circ\text{C}$		
Maximum peak, one-cycle, on-state non-repetitive surge current	$I_{TSM}$	$t = 10\text{ ms}$	No voltage reapplied	Sine half wave, initial $T_J = T_J$ maximum	1900	A		
		$t = 8.3\text{ ms}$			1995			
Maximum $I^2t$ for fusing	$I^2t$	$t = 10\text{ ms}$	100% $V_{RRM}$ reapplied	Sine half wave, initial $T_J = T_J$ maximum	18	$\text{kA}^2\text{s}$		
		$t = 8.3\text{ ms}$			16.4			
		$t = 10\text{ ms}$			12.6			
		$t = 8.3\text{ ms}$			11.5			
Maximum $I^2\sqrt{t}$ for fusing	$I^2\sqrt{t}$	$t = 0.1\text{ ms to }10\text{ ms}$ , no voltage reapplied			180.5	$\text{kA}^2\sqrt{\text{s}}$		
Maximum on-state voltage drop	$V_{TM}$	$I_{TM} = 200\text{A}$ , $T_J = 25^\circ\text{C}$ , 180° conduction			1.3	V		
Maximum holding current	$I_H$	Anode supply = 12 V initial $I_T = 30\text{ A}$ , $T_J = 25^\circ\text{C}$			200	mA		
Maximum latching current	$I_L$	Anode supply = 12 V resistive load = 1 $\Omega$ Gate pulse: 10 V, 100 $\mu\text{s}$ , $T_J = 25^\circ\text{C}$			400			

SWITCHING						
PARAMETER	SYMBOL	TEST CONDITIONS			VALUES	UNITS
Typical delay time	$t_d$	$T_J = 25^\circ\text{C}$ , gate current = 1A $dI_g/dt = 1\text{ A}/\mu\text{s}$			1	$\mu\text{s}$
					2	
Typical rise time	$t_r$	$V_d = 0.67\% V_{DRM}$				
Typical turn-off time	$t_q$	$I_{TM} = 300\text{A}$ ; $dI/dt = 15\text{ A}/\mu\text{s}$ ; $T_J = T_J$ maximum, $V_R = 50\text{V}$ ; $dV/dt = 20\text{V}/\mu\text{s}$ ; gate 0V, 100 $\Omega$			50 to 150	

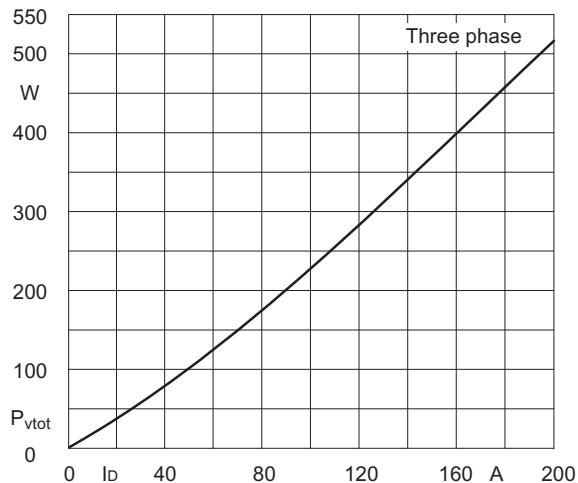
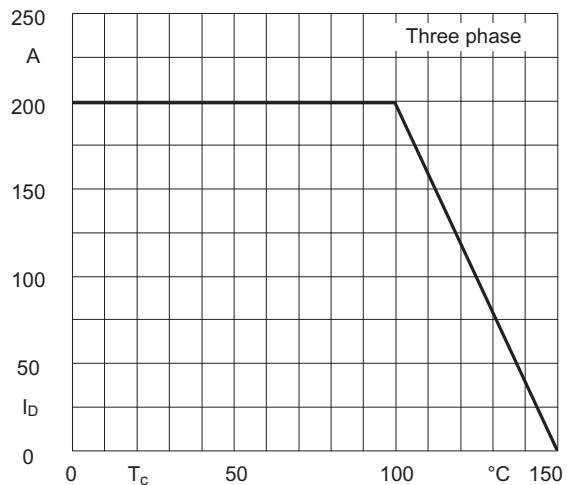
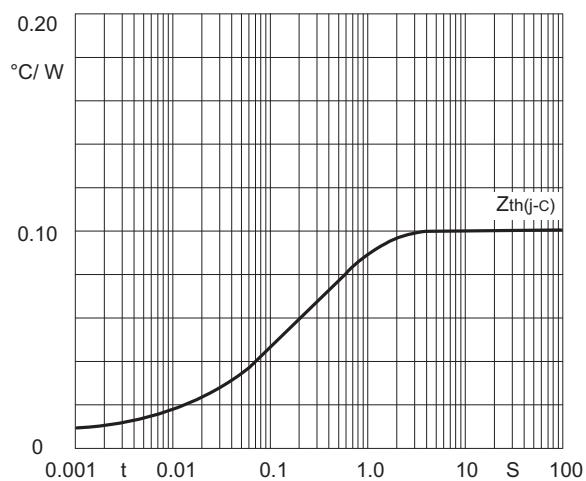
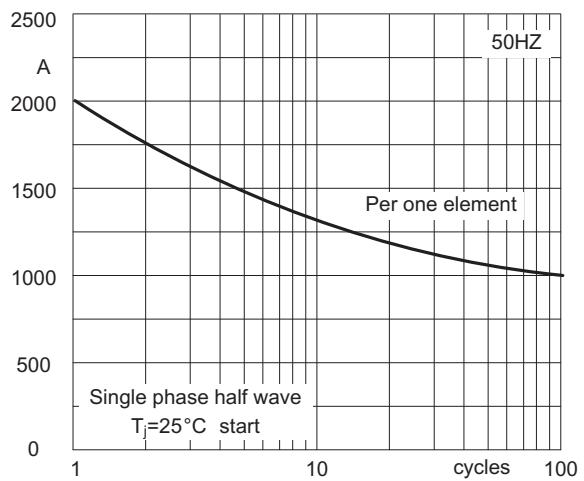
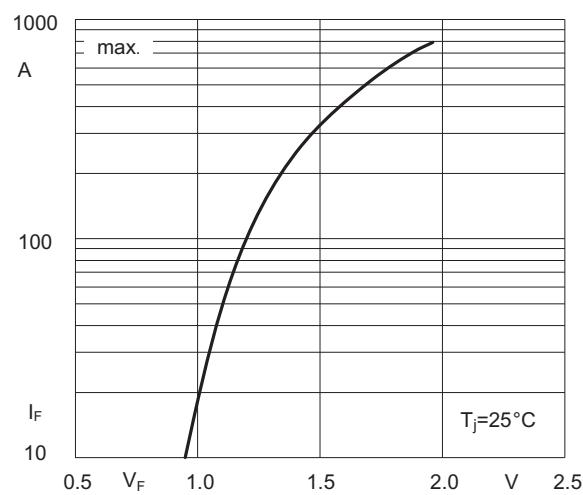
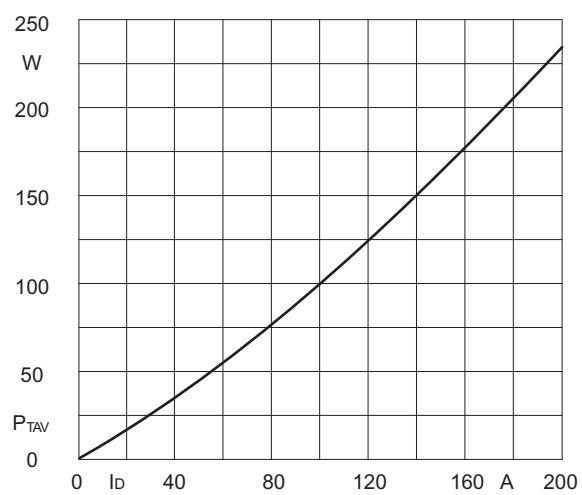
<b>BLOCKING</b>				
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS
Maximum peak reverse and off-state leakage current	$I_{RRM}$ , $I_{DRM}$	$T_J = 125^\circ C$	30	mA
RMS isolation Voltage	$V_{ISO}$	50 Hz, circuit to base, all terminals shorted, $25^\circ C$ , 60s	3000	V
Critical rate of rise of off-state voltage	$dV/dt$	$T_J = T_J$ maximum, exponential to 67 % rated $V_{DRM}$	500	V/ $\mu$ s

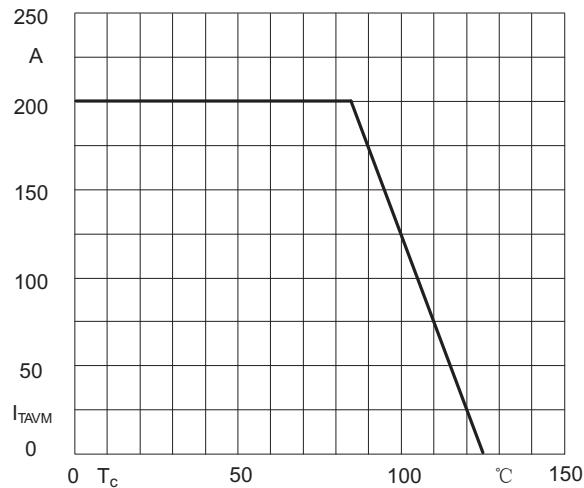
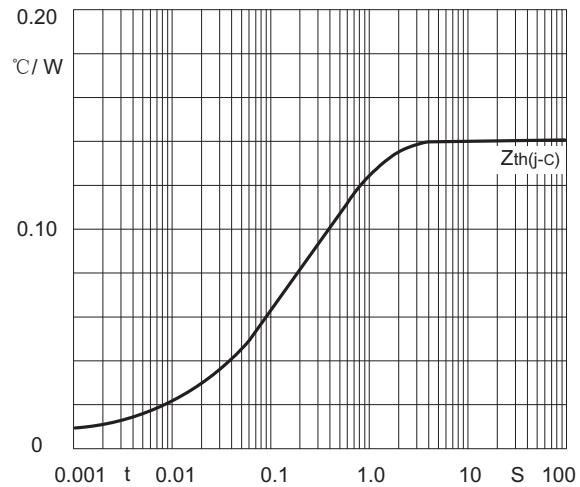
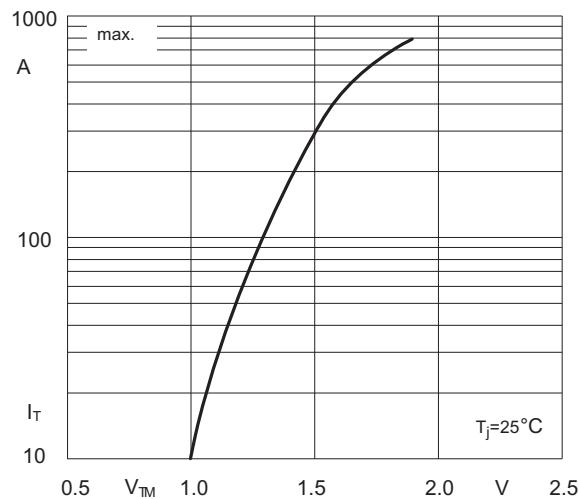
<b>TRIGGERING</b>				
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS
Maximum peak gate power	$P_{GM}$	$t_p \leq 5$ ms, $T_J = T_J$ maximum	15	W
Maximum average gate power	$P_{G(AV)}$	$f = 50$ Hz, $T_J = T_J$ maximum	5	
Maximum peak gate current	$I_{GM}$	$t_p \leq 5$ ms, $T_J = T_J$ maximum	3	A
Maximum peak negative gate voltage	- $V_{GT}$		10	V
Maximum required DC gate voltage to trigger	$V_{GT}$	$T_J = 25^\circ C$	3	
Maximum required DC gate current to trigger	$I_{GT}$		100	mA
Maximum gate voltage that will not trigger	$V_{GD}$	$T_J = T_J$ maximum, 67% $V_{DRM}$ applied	0.25	V
Maximum gate current that will not trigger	$I_{GD}$		10	mA
Maximum rate of rise of turned-on current	$dI/dt$	$T_J = 25^\circ C$ , $I_{GM} = 1.5A$ , $t_r \leq 0.5$ $\mu$ s	200	A/ $\mu$ s

<b>THERMAL AND MECHANICAL SPECIFICATIONS</b>				
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS
junction operating and storage temperature range	$T_J$ , $T_{stg}$		- 40 to 125	°C
Maximum thermal resistance, junction to case per junction	$R_{thJC}$	DC operation	0.14	°C/W
Typical thermal resistance, case to heatsink per module	$R_{thcs}$	Mounting surface, smooth, flat and greased	0.06	
Mounting to heatsink, M6 torque ± 10 % to terminal, M6/M4		A mounting compound is recommended and the torque should be rechecked after a period of about 3 hours to allow for the spread of the compound.	5	N.m
			5 / 2	
Approximate weight			470	g
			16.6	oz.



- [1] - Module type : "MTPT" for 3Ø Bridge + Thyristor
- [2] -  $I_{F(AV)}$  rating : "200" for 200 A
- [3] - Voltage code : code x 100 =  $V_{RRM}$

**Fig.1 Power dissipation**

**Fig.2 Forward current derating curve**

**Fig.3 Transient thermal impedance**

**Fig.4 Max non-repetitive forward surge current**

**Fig.5 Forward characteristics**

**Fig.6 SCR power dissipation**


**Fig.7 SCR forward current derating curve**

**Fig.8 SCR transient thermal impedance**

**Fig.9 SCR forward characteristics**

**Fig.10 Gate trigger characteristics**
